

# HERMETIC PACKAGING

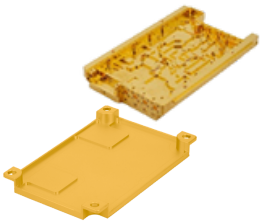
## Components

2025

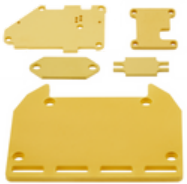


SURON provides a comprehensive range of components for microelectronic hermetic packaging. With cutting-edge technological expertise, our in-house capabilities include plating and coating.

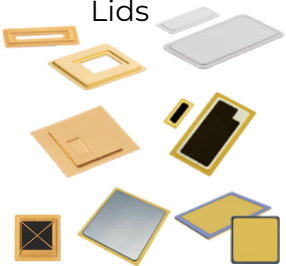
Metal Packages



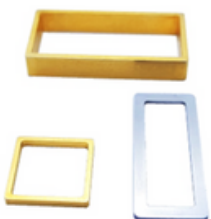
Carriers/Heat Spreaders



Lids



Rings



### Components

- Lids
- Metal Packages
- Heat Dissipation Substrates
- Rings

### Surface Finishes

- Gold Plating  
Immersion & Electrolytic  
(Hard and Soft)
- Nickel Plating  
Electroless & Electrolytic



### Materials

- CTE Compatible to Glass: Kovar, Alloy42 and more
- Thermal Management Alloys: MoCu, WCu and more



**SURON**  
Precision Solutions